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## **RECORDATION FORM**

DATENTS (

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To the Director of the U.S. Patent and Trademark Office: Please	record the attached documents or the new address(es) below.
1. Name of conveying party(les)/Execution Date(s): OSAMU MAEDA (02/02/2010), TAKEHIRO TANIGUCHI (02/02/2010), AND TAKAHIRO ARAKIDA (02/03/2010)	2. Name and address of receiving party(ies)
, í	Name: SONY CORPORATION
	Internal Address:
Execution Date(s): in parentheses after inventor name	Street Address:
Additional name(s) of conveying party(les) attached?	1-7-1 Konan, Minato-ku
3. Nature of Conveyance:	Tokyo
X Assignment Merger	108-0075
	JAPAN
Security Agreement Change of Name	City:
Government Interest Assignment	State:
Executive Order 9424, Confirmatory License	Country: Zip:
Other 12661067	Additional name(s) & address(es) Yes X No attached:
	Lattachieu.
4. Application or patent number(s):  A. Patent Application No.(s)  This application	This document is being filed together with a new application.  B. Patent No.(s)
Additional numbers attached?	
5. Name and address to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
Name: Dennis M. Smid, Esq. LERNER, DAVID, LITTENBERG, KRUMHOLZ & MENTLIK, LLP	7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00
Internal Address: Atty. Dkt.: SONYJP 3.0-2194	Authorized to be charged by credit card
Street Address: 600 South Avenue West	X Authorized to be charged to deposit account  Enclosed  None required (government interest not affecting title)
City: Westfield	8. Payment Information
State: NJ Zip: 07090	a. Credit Card Last 4 Numbers
Phone Number: (908) 518-6374	03/22/20 <b>58/9/JAHRY D-000</b> 00041 121095 1266106
Fax Number: (908) 654-0415	b. Deposit Account Number 12-1095
Email Address: dsmid@ldlkpg.com	Authorized User Name Dennis M. Smid, Esq.
9. Signature:	March 10, 2010
Signature	Date
Dennis M. Smid, Esq 34,930  Name of Person Signing	Total number of pages including cover sheet, attachments, and documents: 2

Attorney Docket No. SONYJP3.0-2194 SONY Ref. No.: S10P0434US00

## **ASSIGNMENT**

WHEREAS, I, as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in SEMICONDUCTOR LASER

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address

AND WHEREAS, SONY CORPORATION, a Japanese corporation, with offices at 1-7-1 Konan, Minato-ku, Tokyo, Japan (hereinaft referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficient of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign therefore which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filling applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto:

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or it designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Lette patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to satisfaction, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and witestify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in the spaces that follow: Serial Number:	this application to insert the serial number and filing date of this application : Filing Date:
This assignment executed on the dates indicated below.	
OSAMU MAEDA	
Name of first or sole inventor KANAGAWA JAPAN	Execution date of U.S. Patent Application
Residence of First or sole inventor	Feb. 2, 20/0
Signature of first or sole inventor	Date of this assignment
TAKEHIRO TANIGUCHI	•
Name of second inventor TOKYO JAPAN	Execution date of U.S. Patent Application
Residence of second inventor	Feb. 2, 20/0 Date of this assignment
Signature of second inventor	Date of this assignment
TAKAHIRO ARAKIDA	
Name of third inventor KANAGAWA JAPAN	Execution date of U.S. Patent Application
Residence of third inventor	February 3, 20/0
Signature of third inventor	Date of this assignment

1

PATENT REEL: 024119 FRAME: 0858

RECORDED: 03/10/2010